



**MODULAR APPROVAL
Attestation letter**

September 5th, 2023

Timco Engineering, Inc
849 NW State Road 45
Newberry, Florida 32669 - United States

Re: Modular Approval attestation letter
FCC ID: YCP- 32WB1MMCH01
IC: 8976A- 32WB1MMCH01

Gentlemen,

The module **STM32WB1MMC** meets the requirements for modular approval as detailed in FCC Public notice 15.212 and IC RSS requirements.

Compliance to each of the requirements is described below.

Clauses		Manufacturer's arguments Modular Approval
15.212 (a)(1)(i)	Shielding	The module has a metal shield over the radio elements
15.212 (a)(1)(ii)	Buffered Data/Modulation	STM32WB1MMC is compliant with this rule.
15.212 (a)(1)(iii)	Power supply regulation	STM32WB1MMC is compliant with this rule
15.212 (a)(1)(iv)	Antenna	The antenna is permanently attached to the STM32WB1MMC inside the substrate.
15.212 (a)(1)(v)	Stand-alone configuration	The STM32WB1MMC was tested in a stand-alone configuration, see "Test setup photos" document.
15.212 (a)(1)(vi)	Label	See "Label" document and exhibition label sample
15.212 (a)(1)(vii)	Operating	The STM32WB1MMC is compliant with all applicable FCC and IC rules. Details for maintaining compliance are given in the "Datasheet".
15.212 (a)(1)(viii)	RF Exposure	The STM32WB1MMC is compliant with all applicable RF exposure requirements. See "RF exposure" document.

Please contact me if you have any further question.
Best regards,

Responsible: Pascal Scafidi
Title: MDG Group VP Quality & Reliability

Signature:

DocuSigned by:
Pascal SCAFIDI
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